

Global Solder Ball Market Report 2019, Competitive Landscape, Trends and Opportunities

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Abstracts

The Solder Ball market has witnessed growth from USD XX million to USD XX million from 2014 to 2019. With the CAGR of X.X%, this market is estimated to reach USD XX million in 2026.

The report mainly studies the size, recent trends and development status of the Solder Ball market, as well as investment opportunities, government policy, market dynamics (drivers, restraints, opportunities), supply chain and competitive landscape. Technological innovation and advancement will further optimize the performance of the product, making it more widely used in downstream applications. Moreover, Porter's Five Forces Analysis (potential entrants, suppliers, substitutes, buyers, industry competitors) provides crucial information for knowing the Solder Ball market.

Major players in the global Solder Ball market include:

Accurus

PMTC

MKE

YCTC

Nippon Micrometal

Senju Metal

Shanghai hiking solder material

Shenmao Technology

DS HiMetal

Hitachi Metals Nanotech

On the basis of types, the Solder Ball market is primarily split into:

Lead Solder Balls

Lead Free Solder Balls

On the basis of applications, the market covers:

Automotive

Electronic

Others

Geographically, the report includes the research on production, consumption, revenue, market share and growth rate, and forecast (2014-2026) of the following regions:

United States

Europe (Germany, UK, France, Italy, Spain, Russia, Poland)

China

Japan

India

Southeast Asia (Malaysia, Singapore, Philippines, Indonesia, Thailand, Vietnam)

Central and South America (Brazil, Mexico, Colombia)

Middle East and Africa (Saudi Arabia, United Arab Emirates, Turkey, Egypt, South Africa, Nigeria)

Other Regions

Chapter 1 provides an overview of Solder Ball market, containing global revenue, global production, sales, and CAGR. The forecast and analysis of Solder Ball market by type, application, and region are also presented in this chapter.

Chapter 2 is about the market landscape and major players. It provides competitive situation and market concentration status along with the basic information of these players.

Chapter 3 provides a full-scale analysis of major players in Solder Ball industry. The basic information, as well as the profiles, applications and specifications of products market performance along with Business Overview are offered.

Chapter 4 gives a worldwide view of Solder Ball market. It includes production, market share revenue, price, and the growth rate by type.

Chapter 5 focuses on the application of Solder Ball, by analyzing the consumption and its growth rate of each application.

Chapter 6 is about production, consumption, export, and import of Solder Ball in each

region.

Chapter 7 pays attention to the production, revenue, price and gross margin of Solder Ball in markets of different regions. The analysis on production, revenue, price and gross margin of the global market is covered in this part.

Chapter 8 concentrates on manufacturing analysis, including key raw material analysis, cost structure analysis and process analysis, making up a comprehensive analysis of manufacturing cost.

Chapter 9 introduces the industrial chain of Solder Ball. Industrial chain analysis, raw material sources and downstream buyers are analyzed in this chapter.

Chapter 10 provides clear insights into market dynamics.

Chapter 11 prospects the whole Solder Ball market, including the global production and revenue forecast, regional forecast. It also foresees the Solder Ball market by type and application.

Chapter 12 concludes the research findings and refines all the highlights of the study.

Chapter 13 introduces the research methodology and sources of research data for your understanding.

Years considered for this report:

Historical Years: 2014-2018

Base Year: 2019

Estimated Year: 2019

Forecast Period: 2019-2026

Contents

1 SOLDER BALL MARKET OVERVIEW

- 1.1 Product Overview and Scope of Solder Ball
- 1.2 Solder Ball Segment by Type
 - 1.2.1 Global Solder Ball Production and CAGR (%) Comparison by Type (2014-2026)
 - 1.2.2 The Market Profile of Lead Solder Balls
 - 1.2.3 The Market Profile of Lead Free Solder Balls
- 1.3 Global Solder Ball Segment by Application
 - 1.3.1 Solder Ball Consumption (Sales) Comparison by Application (2014-2026)
 - 1.3.2 The Market Profile of Automotive
 - 1.3.3 The Market Profile of Electronic
 - 1.3.4 The Market Profile of Others
- 1.4 Global Solder Ball Market by Region (2014-2026)
 - 1.4.1 Global Solder Ball Market Size (Value) and CAGR (%) Comparison by Region (2014-2026)
 - 1.4.2 United States Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3 Europe Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.1 Germany Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.2 UK Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.3 France Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.4 Italy Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.5 Spain Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.6 Russia Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.3.7 Poland Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.4 China Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.5 Japan Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.6 India Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7 Southeast Asia Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7.1 Malaysia Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7.2 Singapore Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7.3 Philippines Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7.4 Indonesia Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7.5 Thailand Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.7.6 Vietnam Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.8 Central and South America Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.8.1 Brazil Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.8.2 Mexico Solder Ball Market Status and Prospect (2014-2026)

- 1.4.8.3 Colombia Solder Ball Market Status and Prospect (2014-2026)
- 1.4.9 Middle East and Africa Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.9.1 Saudi Arabia Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.9.2 United Arab Emirates Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.9.3 Turkey Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.9.4 Egypt Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.9.5 South Africa Solder Ball Market Status and Prospect (2014-2026)
 - 1.4.9.6 Nigeria Solder Ball Market Status and Prospect (2014-2026)
- 1.5 Global Market Size (Value) of Solder Ball (2014-2026)
 - 1.5.1 Global Solder Ball Revenue Status and Outlook (2014-2026)
 - 1.5.2 Global Solder Ball Production Status and Outlook (2014-2026)

2 GLOBAL SOLDER BALL MARKET LANDSCAPE BY PLAYER

- 2.1 Global Solder Ball Production and Share by Player (2014-2019)
- 2.2 Global Solder Ball Revenue and Market Share by Player (2014-2019)
- 2.3 Global Solder Ball Average Price by Player (2014-2019)
- 2.4 Solder Ball Manufacturing Base Distribution, Sales Area and Product Type by Player
- 2.5 Solder Ball Market Competitive Situation and Trends
 - 2.5.1 Solder Ball Market Concentration Rate
 - 2.5.2 Solder Ball Market Share of Top 3 and Top 6 Players
 - 2.5.3 Mergers & Acquisitions, Expansion

3 PLAYERS PROFILES

- 3.1 Accurus
 - 3.1.1 Accurus Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.1.2 Solder Ball Product Profiles, Application and Specification
 - 3.1.3 Accurus Solder Ball Market Performance (2014-2019)
 - 3.1.4 Accurus Business Overview
- 3.2 PMTC
 - 3.2.1 PMTC Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.2.2 Solder Ball Product Profiles, Application and Specification
 - 3.2.3 PMTC Solder Ball Market Performance (2014-2019)
 - 3.2.4 PMTC Business Overview
- 3.3 MKE
 - 3.3.1 MKE Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.3.2 Solder Ball Product Profiles, Application and Specification

- 3.3.3 MKE Solder Ball Market Performance (2014-2019)
- 3.3.4 MKE Business Overview
- 3.4 YCTC
 - 3.4.1 YCTC Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.4.2 Solder Ball Product Profiles, Application and Specification
 - 3.4.3 YCTC Solder Ball Market Performance (2014-2019)
 - 3.4.4 YCTC Business Overview
- 3.5 Nippon Micrometal
 - 3.5.1 Nippon Micrometal Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.5.2 Solder Ball Product Profiles, Application and Specification
 - 3.5.3 Nippon Micrometal Solder Ball Market Performance (2014-2019)
 - 3.5.4 Nippon Micrometal Business Overview
- 3.6 Senju Metal
 - 3.6.1 Senju Metal Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.6.2 Solder Ball Product Profiles, Application and Specification
 - 3.6.3 Senju Metal Solder Ball Market Performance (2014-2019)
 - 3.6.4 Senju Metal Business Overview
- 3.7 Shanghai hiking solder material
 - 3.7.1 Shanghai hiking solder material Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.7.2 Solder Ball Product Profiles, Application and Specification
 - 3.7.3 Shanghai hiking solder material Solder Ball Market Performance (2014-2019)
 - 3.7.4 Shanghai hiking solder material Business Overview
- 3.8 Shenmao Technology
 - 3.8.1 Shenmao Technology Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.8.2 Solder Ball Product Profiles, Application and Specification
 - 3.8.3 Shenmao Technology Solder Ball Market Performance (2014-2019)
 - 3.8.4 Shenmao Technology Business Overview
- 3.9 DS HiMetal
 - 3.9.1 DS HiMetal Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.9.2 Solder Ball Product Profiles, Application and Specification
 - 3.9.3 DS HiMetal Solder Ball Market Performance (2014-2019)
 - 3.9.4 DS HiMetal Business Overview
- 3.10 Hitachi Metals Nanotech
 - 3.10.1 Hitachi Metals Nanotech Basic Information, Manufacturing Base, Sales Area and Competitors
 - 3.10.2 Solder Ball Product Profiles, Application and Specification

3.10.3 Hitachi Metals Nanotech Solder Ball Market Performance (2014-2019)

3.10.4 Hitachi Metals Nanotech Business Overview

4 GLOBAL SOLDER BALL PRODUCTION, REVENUE (VALUE), PRICE TREND BY TYPE

4.1 Global Solder Ball Production and Market Share by Type (2014-2019)

4.2 Global Solder Ball Revenue and Market Share by Type (2014-2019)

4.3 Global Solder Ball Price by Type (2014-2019)

4.4 Global Solder Ball Production Growth Rate by Type (2014-2019)

4.4.1 Global Solder Ball Production Growth Rate of Lead Solder Balls (2014-2019)

4.4.2 Global Solder Ball Production Growth Rate of Lead Free Solder Balls (2014-2019)

5 GLOBAL SOLDER BALL MARKET ANALYSIS BY APPLICATION

5.1 Global Solder Ball Consumption and Market Share by Application (2014-2019)

5.2 Global Solder Ball Consumption Growth Rate by Application (2014-2019)

5.2.1 Global Solder Ball Consumption Growth Rate of Automotive (2014-2019)

5.2.2 Global Solder Ball Consumption Growth Rate of Electronic (2014-2019)

5.2.3 Global Solder Ball Consumption Growth Rate of Others (2014-2019)

6 GLOBAL SOLDER BALL PRODUCTION, CONSUMPTION, EXPORT, IMPORT BY REGION (2014-2019)

6.1 Global Solder Ball Consumption by Region (2014-2019)

6.2 United States Solder Ball Production, Consumption, Export, Import (2014-2019)

6.3 Europe Solder Ball Production, Consumption, Export, Import (2014-2019)

6.4 China Solder Ball Production, Consumption, Export, Import (2014-2019)

6.5 Japan Solder Ball Production, Consumption, Export, Import (2014-2019)

6.6 India Solder Ball Production, Consumption, Export, Import (2014-2019)

6.7 Southeast Asia Solder Ball Production, Consumption, Export, Import (2014-2019)

6.8 Central and South America Solder Ball Production, Consumption, Export, Import (2014-2019)

6.9 Middle East and Africa Solder Ball Production, Consumption, Export, Import (2014-2019)

7 GLOBAL SOLDER BALL PRODUCTION, REVENUE (VALUE) BY REGION (2014-2019)

- 7.1 Global Solder Ball Production and Market Share by Region (2014-2019)
- 7.2 Global Solder Ball Revenue (Value) and Market Share by Region (2014-2019)
- 7.3 Global Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.4 United States Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.5 Europe Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.6 China Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.7 Japan Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.8 India Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.9 Southeast Asia Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.10 Central and South America Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)
- 7.11 Middle East and Africa Solder Ball Production, Revenue, Price and Gross Margin (2014-2019)

8 SOLDER BALL MANUFACTURING ANALYSIS

- 8.1 Solder Ball Key Raw Materials Analysis
 - 8.1.1 Key Raw Materials Introduction
 - 8.1.2 Price Trend of Key Raw Materials
 - 8.1.3 Key Suppliers of Raw Materials
 - 8.1.4 Market Concentration Rate of Raw Materials
- 8.2 Manufacturing Cost Analysis
 - 8.2.1 Labor Cost Analysis
 - 8.2.2 Manufacturing Cost Structure Analysis
- 8.3 Manufacturing Process Analysis of Solder Ball

9 INDUSTRIAL CHAIN, SOURCING STRATEGY AND DOWNSTREAM BUYERS

- 9.1 Solder Ball Industrial Chain Analysis
- 9.2 Raw Materials Sources of Solder Ball Major Players in 2018
- 9.3 Downstream Buyers

10 MARKET DYNAMICS

- 10.1 Drivers
- 10.2 Restraints

10.3 Opportunities

10.3.1 Advances in Innovation and Technology for Solder Ball

10.3.2 Increased Demand in Emerging Markets

10.4 Challenges

10.4.1 The Performance of Alternative Product Type is Getting Better and Better

10.4.2 Price Variance Caused by Fluctuations in Raw Material Prices

10.5 Porter's Five Forces Analysis

10.5.1 Threat of New Entrants

10.5.2 Threat of Substitutes

10.5.3 Bargaining Power of Suppliers

10.5.4 Bargaining Power of Buyers

10.5.5 Intensity of Competitive Rivalry

11 GLOBAL SOLDER BALL MARKET FORECAST (2019-2026)

11.1 Global Solder Ball Production, Revenue Forecast (2019-2026)

11.1.1 Global Solder Ball Production and Growth Rate Forecast (2019-2026)

11.1.2 Global Solder Ball Revenue and Growth Rate Forecast (2019-2026)

11.1.3 Global Solder Ball Price and Trend Forecast (2019-2026)

11.2 Global Solder Ball Production, Consumption, Export and Import Forecast by Region (2019-2026)

11.2.1 United States Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.2 Europe Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.3 China Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.4 Japan Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.5 India Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.6 Southeast Asia Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.7 Central and South America Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.2.8 Middle East and Africa Solder Ball Production, Consumption, Export and Import Forecast (2019-2026)

11.3 Global Solder Ball Production, Revenue and Price Forecast by Type (2019-2026)

11.4 Global Solder Ball Consumption Forecast by Application (2019-2026)

12 RESEARCH FINDINGS AND CONCLUSION

13 APPENDIX

13.1 Methodology

13.2 Research Data Source

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